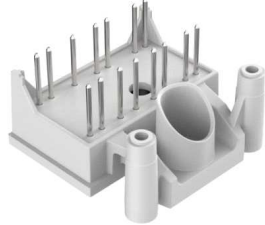
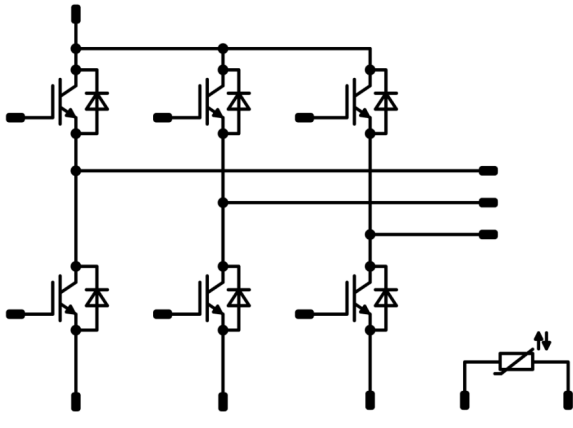




Vincotech

<i>flow</i> PACK 0 B	600 V / 10 A
<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Features</p> <ul style="list-style-type: none"> IGBT3 (600 V) technology Open emitter topology New ultra-compact housing Single-screw heat sink mounting </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Target applications</p> <ul style="list-style-type: none"> Dedicated design for motor drive </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Types</p> <ul style="list-style-type: none"> 10-0B066PA010SB-M993F09 </div>	<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;"><i>flow</i>0 B 17 mm housing</p>  </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Schematic</p>  </div>

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	14	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	30	A
Turn off safe operating area		$T_j \leq 150\text{ °C}$, $V_{CE} \leq 600\text{ V}$	30	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	34	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150\text{ °C}$ $V_{GE} = 15\text{ V}$	6 360	μs V
Maximum Junction Temperature	T_{jmax}		175	°C



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		600	V
DC forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	17	A
Repetitive peak forward current	I_{FRM}		20	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	33	W
Maximum Junction Temperature	T_{jmax}		175	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage $t_p = 2\text{ s}$	4000	V
Creepage distance			min. 12,5	mm
Clearance			min. 12,5	mm
Comparative Tracking Index	CTI		> 200	



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_C [A] I_D [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}$				0,00015	25	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15			10	25 150	1,1	1,50 1,79	1,9	V
Collector-emitter cut-off current	I_{CES}		0	600			25			0,6	μA
Gate-emitter leakage current	I_{GES}		20	0			25			300	nA
Internal gate resistance	r_g								none		Ω
Input capacitance	C_{ies}								551		pF
Output capacitance	C_{oes}	$f=1\text{ MHz}$	0	25		25			40		
Reverse transfer capacitance	C_{res}								17		
Gate charge	Q_g		15	480	10	25			62		nC

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50\ \mu\text{m}$ $\lambda = 1\ \text{W/mK}$							2,80		K/W
-------------------------------------	---------------	---	--	--	--	--	--	--	------	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 32\ \Omega$ $R_{gon} = 32\ \Omega$	± 15	400	10	25		75		ns
Rise time	t_r					125		74		
Turn-off delay time	$t_{d(off)}$					25		24		
Fall time	t_f					125		26		
Turn-on energy (per pulse)	E_{on}	$Q_{rFWD} = 0,5\ \mu\text{C}$ $Q_{tFWD} = 0,9\ \mu\text{C}$				25		0,277		mWs
Turn-off energy (per pulse)	E_{off}					125		0,376		
						25		0,330		
						125		0,449		



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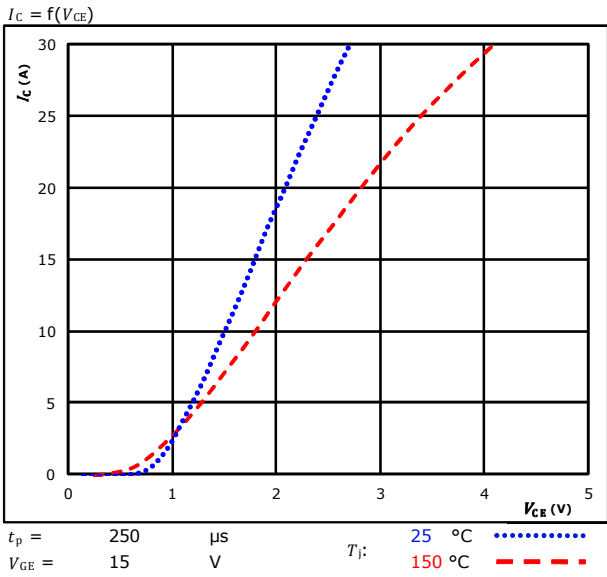
Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V]	I_C [A] I_D [A]	T_j [°C]	Min	Typ	Max		
Inverter Diode										
Static										
Forward voltage	V_F			10	25 150		1,60 1,56	1,95		V
Reverse leakage current	I_{rm}		600		25			27		μA
Thermal										
Thermal resistance chip to heatsink	$R_{th(j-s)}$	Thermal grease thickness ≤ 50 μm $\lambda = 1$ W/mK					2,85			K/W
Dynamic										
Peak recovery current	I_{RRM}	$di/dt = 400$ A/μs $di/dt = 467$ A/μs	±15	400	10	25 125		5 7		A
Reverse recovery time	t_{rr}					25 125		194 270		ns
Recovered charge	Q_r					25 125		0,466 0,896		μC
Reverse recovered energy	E_{rec}					25 125		0,132 0,255		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125		21 65		A/μs
Thermistor										
Rated resistance	R				25		21,5			kΩ
Deviation of R_{100}	$\Delta R/R$	$R_{100} = 1486 \Omega$			100	-4,5		+4,5		%
Power dissipation	P				25		210			mW
Power dissipation constant					25		3,5			mW/K
B-value	$B_{(25/50)}$				25		3884			K
B-value	$B_{(25/100)}$				25		3964			K
Vincotech NTC Reference									F	

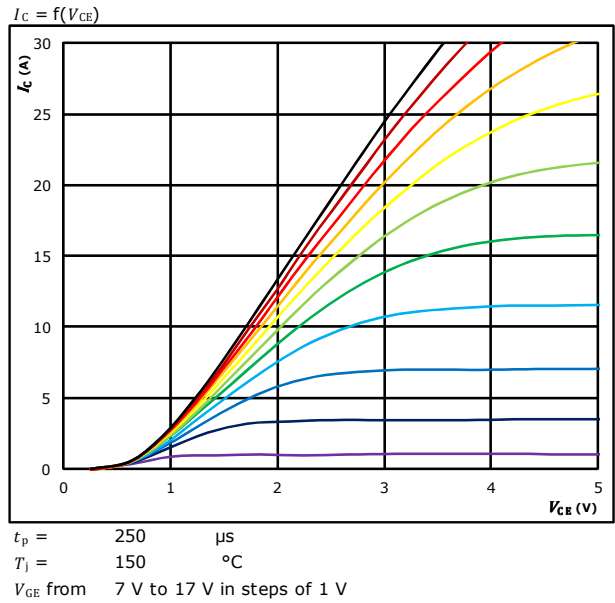


Inverter Switch Characteristics

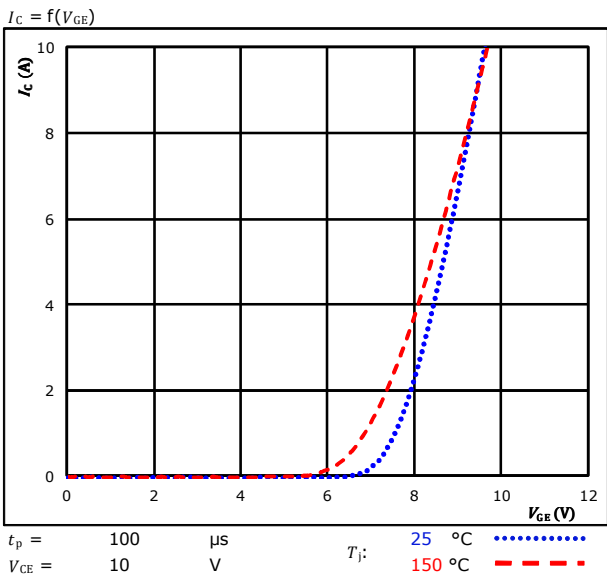
Typical output characteristics IGBT



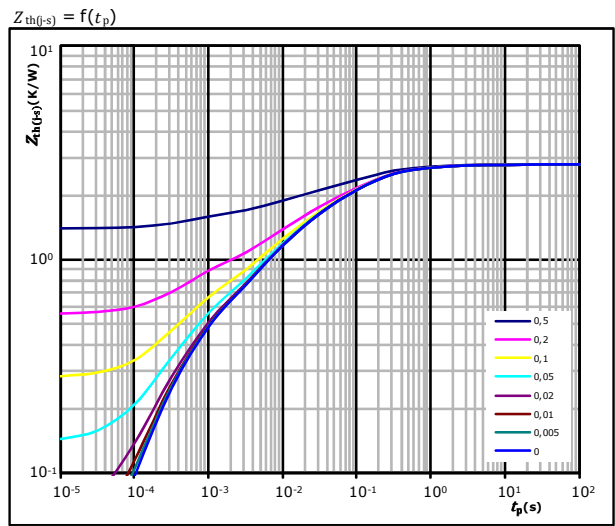
Typical output characteristics IGBT



Typical transfer characteristics IGBT



Transient Thermal Impedance as function of Pulse duration IGBT



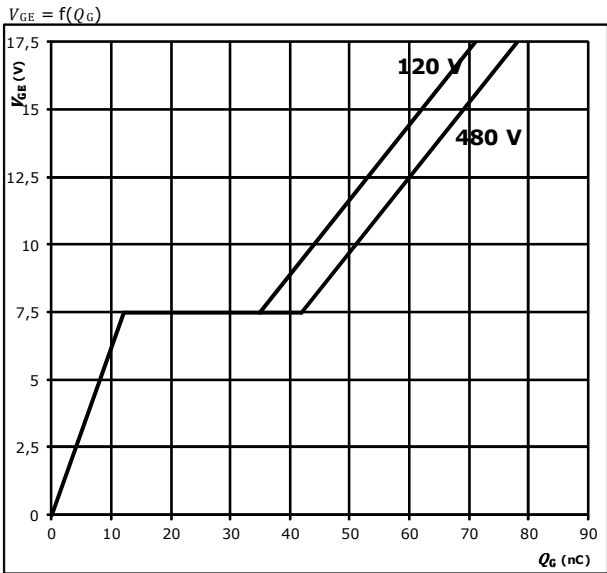
IGBT thermal model values

R (K/W)	τ (s)
4,41E-02	7,36E+00
2,67E-01	6,41E-01
9,50E-01	1,13E-01
7,31E-01	1,82E-02
4,44E-01	3,63E-03
3,64E-01	3,98E-04



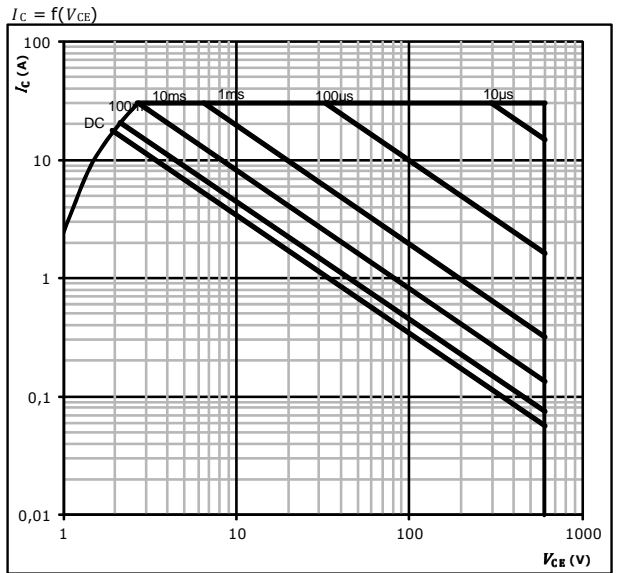
Inverter Switch Characteristics

Gate voltage vs Gate charge IGBT



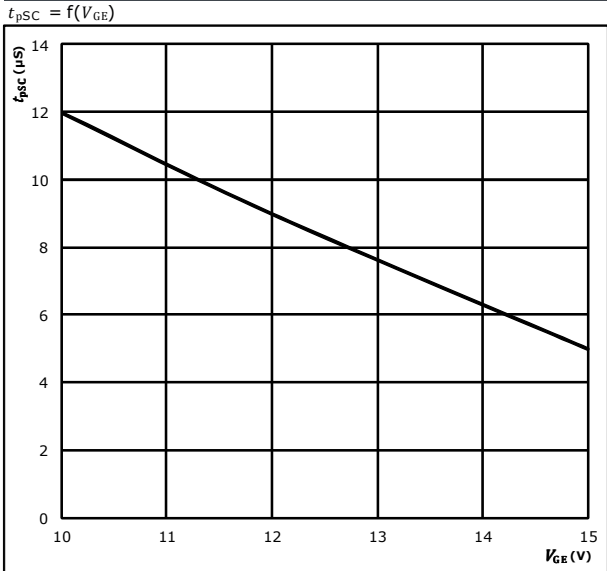
At
 $I_C = 10 \text{ A}$

Safe operating area IGBT

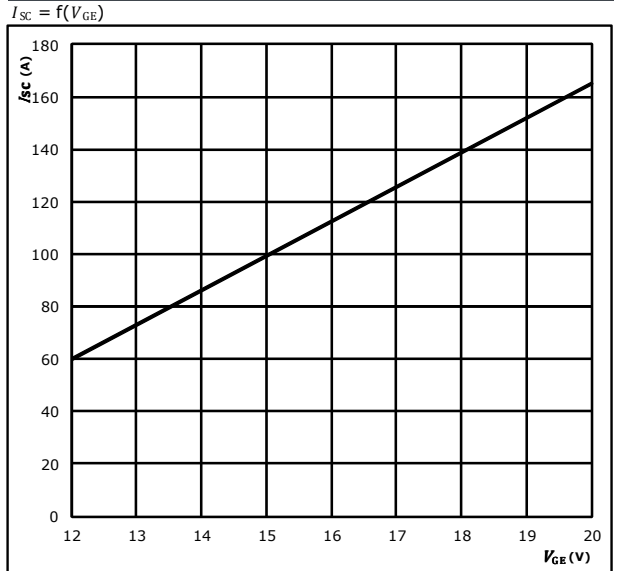


At
 $D =$ single pulse
 $T_s = 80 \text{ }^\circ\text{C}$
 $V_{GE} = \pm 15 \text{ V}$
 $T_j = T_{jmax} \text{ }^\circ\text{C}$

Short circuit duration as a function of V_{GE} IGBT



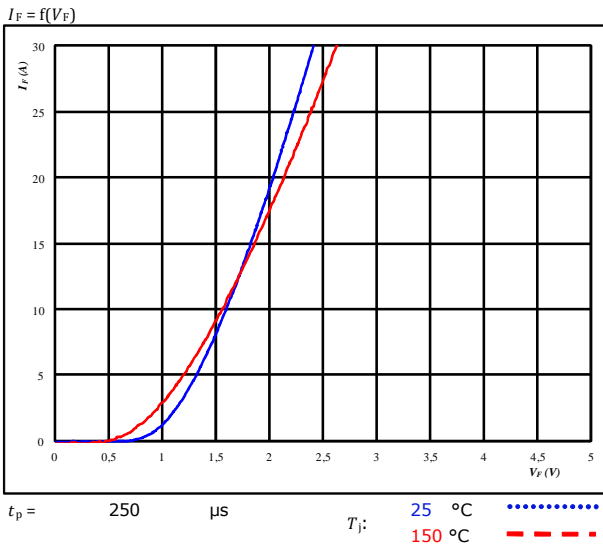
Typical short circuit current as a function of V_{GE} IGBT



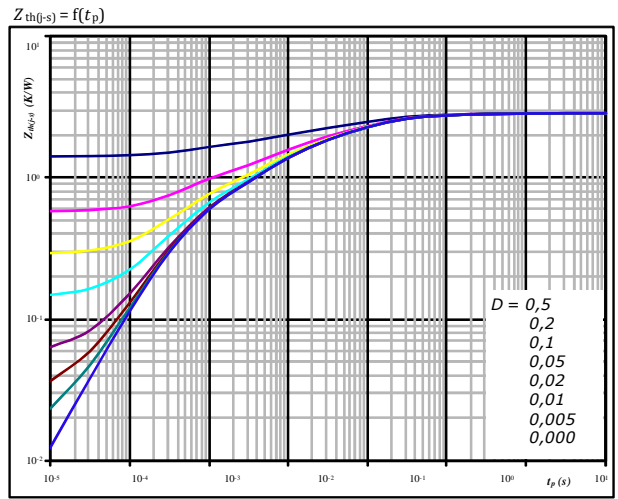


Inverter Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



$D = t_p / T$

$R_{th(j-s)} = 2,85 \text{ K/W}$

FWD thermal model values

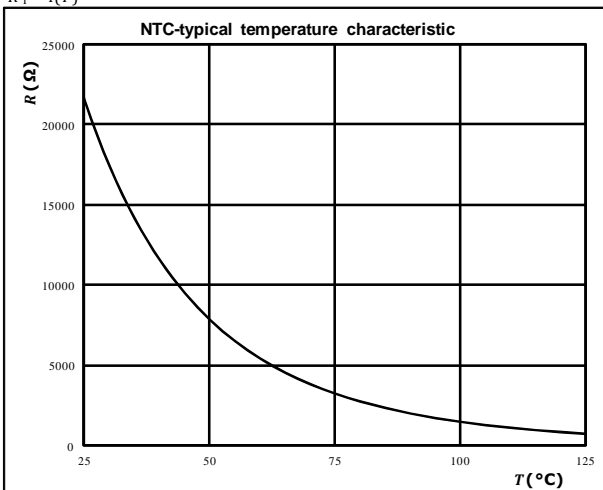
R (K/W)	τ (s)
4,35E-02	9,53E+00
2,14E-01	7,38E-01
7,92E-01	1,19E-01
7,47E-01	1,96E-02
6,00E-01	3,72E-03
4,58E-01	4,38E-04

Thermistor Characteristics

Thermistor typical temperature characteristic

Typical NTC characteristic
as a function of temperature

$R_T = f(T)$

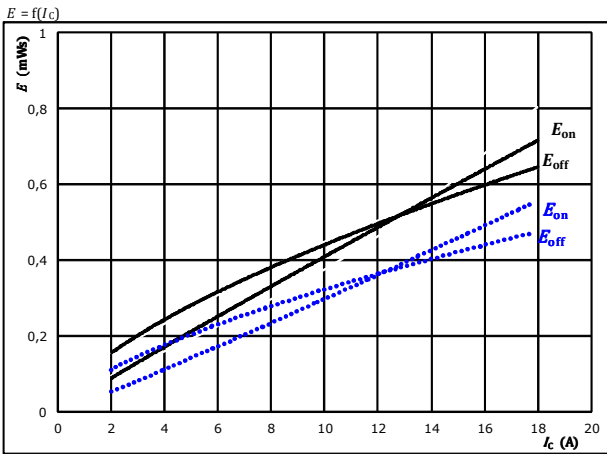




Inverter Switching Characteristics

figure 1. IGBT

Typical switching energy losses as a function of collector current

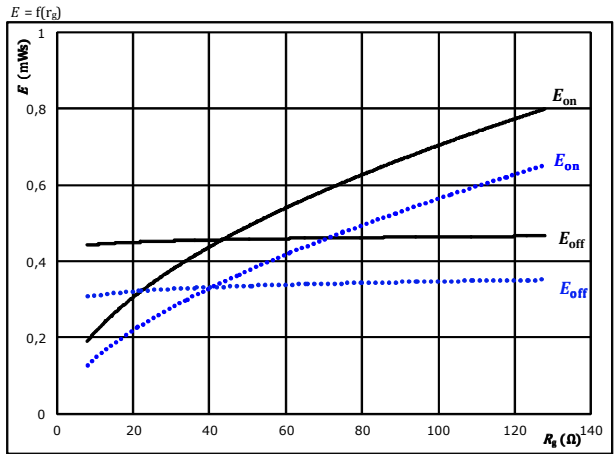


With an inductive load at T_j : 25 °C (dotted blue) / 125 °C (solid black)

$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 32$ Ω
 $R_{goff} = 32$ Ω

figure 2. IGBT

Typical switching energy losses as a function of gate resistor

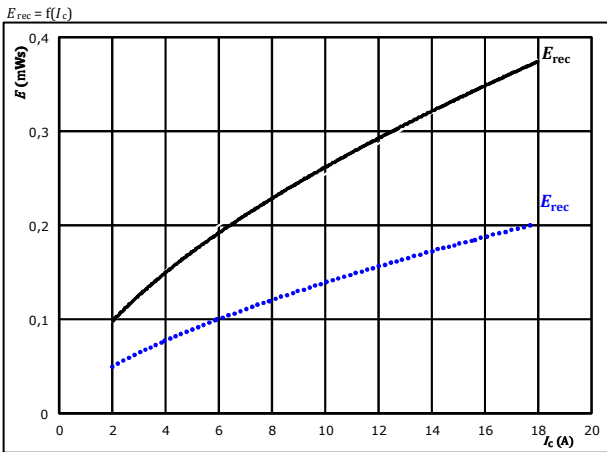


With an inductive load at T_j : 25 °C (dotted blue) / 125 °C (solid black)

$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $I_C = 10$ A

figure 3. FWD

Typical reverse recovered energy loss as a function of collector current

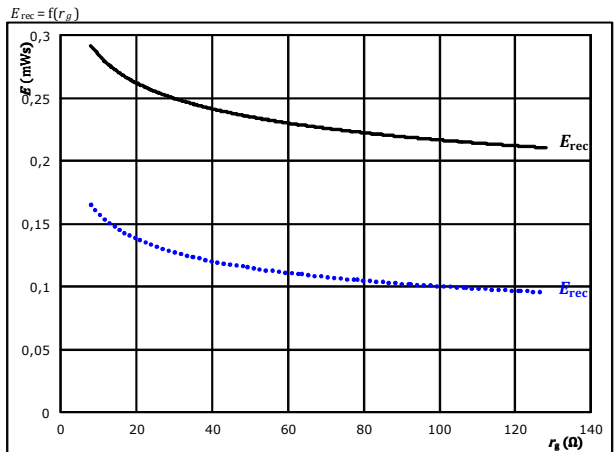


With an inductive load at T_j : 25 °C (dotted blue) / 125 °C (solid black)

$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 32$ Ω

figure 4. FWD

Typical reverse recovered energy loss as a function of gate resistor



With an inductive load at T_j : 25 °C (dotted blue) / 125 °C (solid black)

$V_{CE} = 400$ V
 $V_{GE} = \pm 15$ V
 $I_C = 10$ A

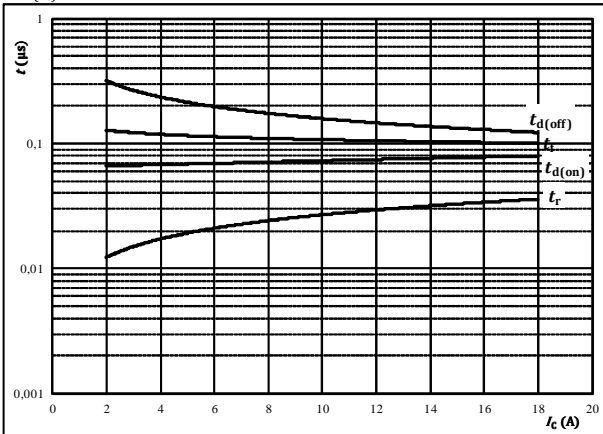


Inverter Switching Characteristics

figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_c)$$



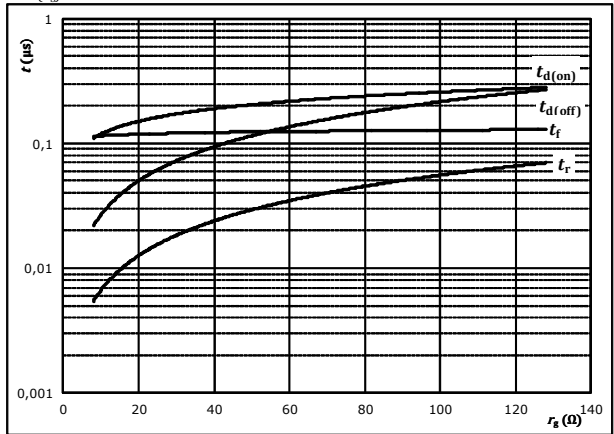
With an inductive load at

$T_j =$	125	°C
$V_{CE} =$	400	V
$V_{GE} =$	±15	V
$R_{gon} =$	32	Ω
$R_{goff} =$	32	Ω

figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(r_g)$$



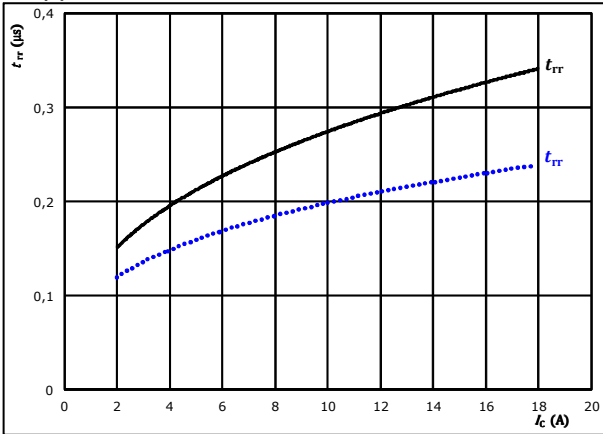
With an inductive load at

$T_j =$	125	°C
$V_{CE} =$	400	V
$V_{GE} =$	±15	V
$I_c =$	10	A

figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_c)$$

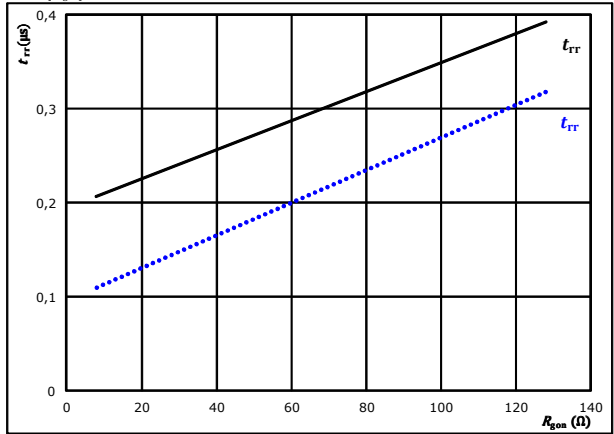


At	$V_{CE} =$	400	V	$T_j =$	25 °C
	$V_{GE} =$	±15	V		125 °C	————
	$R_{gon} =$	32	Ω			

figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At	$V_{CE} =$	400	V	$T_j =$	25 °C
	$V_{GE} =$	±15	V		125 °C	————
	$I_c =$	10	A			

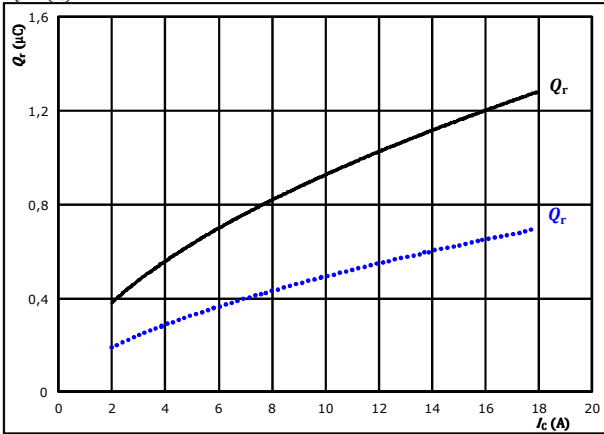


Inverter Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

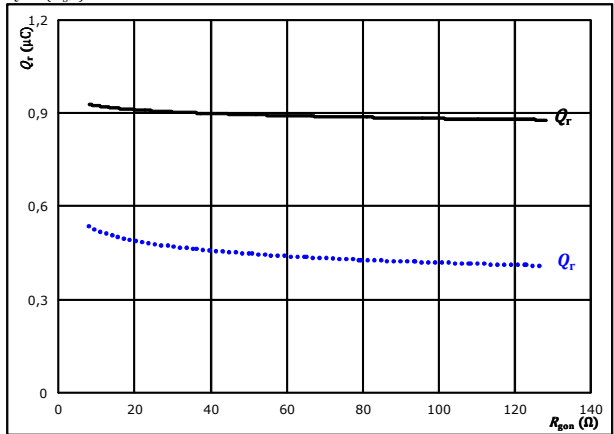


At $V_{CE} = 400$ V $T_j = 25\text{ °C}$ (dotted blue line)
 $V_{GE} = \pm 15$ V $T_j = 125\text{ °C}$ (solid black line)
 $R_{gpn} = 32\ \Omega$

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gpn})$$

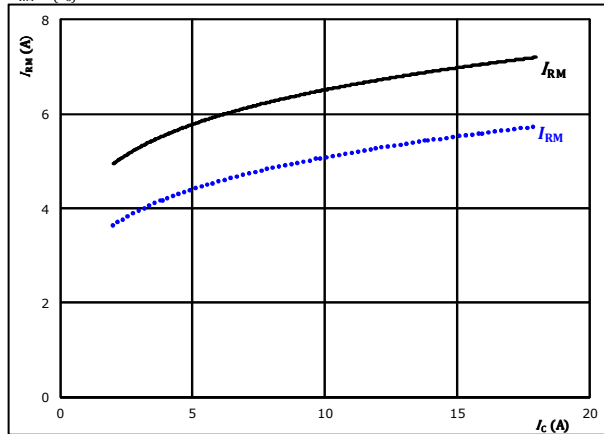


At $V_{CE} = 400$ V $T_j = 25\text{ °C}$ (dotted blue line)
 $V_{GE} = \pm 15$ V $T_j = 125\text{ °C}$ (solid black line)
 $I_c = 10$ A

figure 11. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$

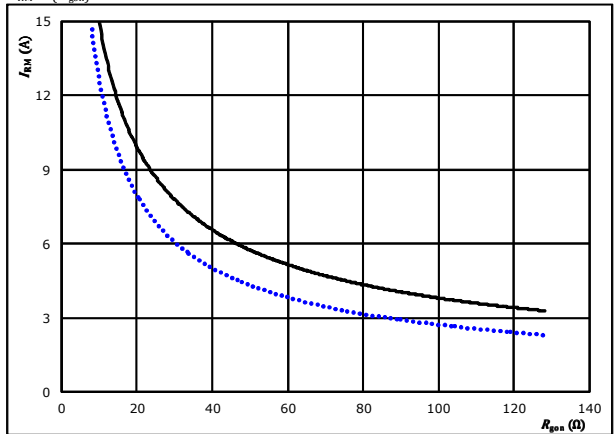


At $V_{CE} = 400$ V $T_j = 25\text{ °C}$ (dotted blue line)
 $V_{GE} = \pm 15$ V $T_j = 125\text{ °C}$ (solid black line)
 $R_{gpn} = 32\ \Omega$

figure 12. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gpn})$$



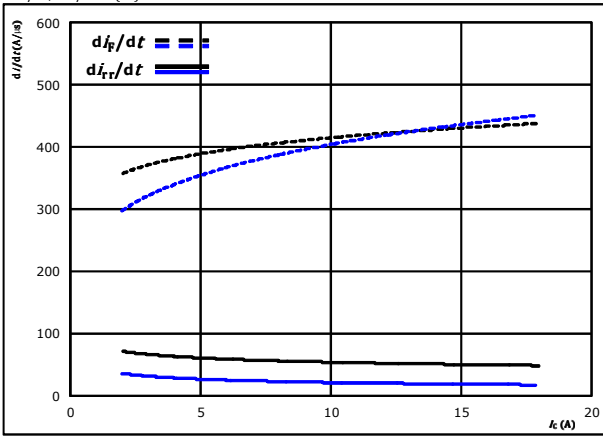
At $V_{CE} = 400$ V $T_j = 25\text{ °C}$ (dotted blue line)
 $V_{GE} = \pm 15$ V $T_j = 125\text{ °C}$ (solid black line)
 $I_c = 10$ A



Inverter Switching Characteristics

figure 13. FWD

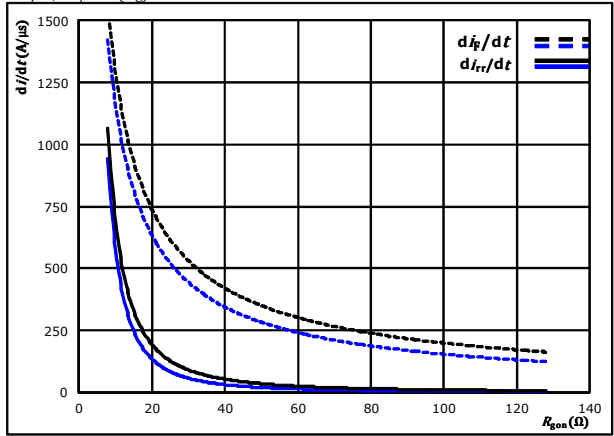
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



At $V_{CE} = 400$ V $T_j = 25$ °C $T_j = 125$ °C
 $V_{GE} = \pm 15$ V
 $R_{gon} = 32$ Ω

figure 14. FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_g)$

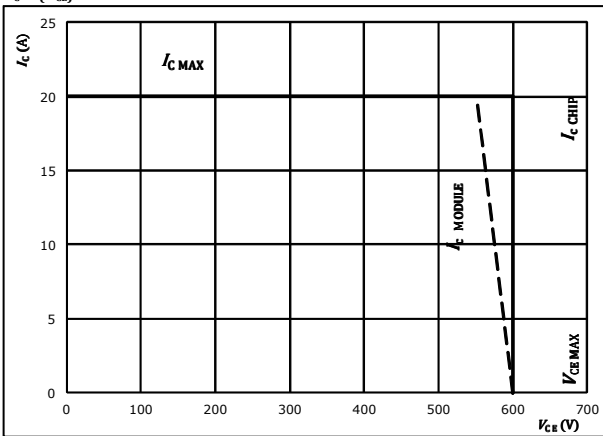


At $V_{CE} = 400$ V $T_j = 25$ °C
 $V_{GE} = \pm 15$ V
 $I_c = 10$ A

figure 15. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



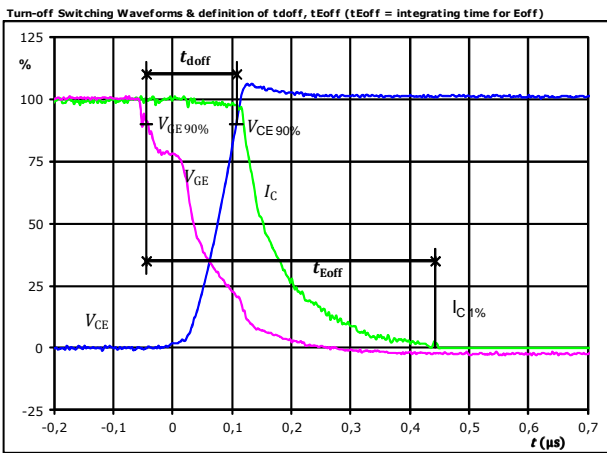
At $T_j = 175$ °C
 $R_{gon} = 32$ Ω
 $R_{goff} = 32$ Ω



Inverter Switching Characteristics

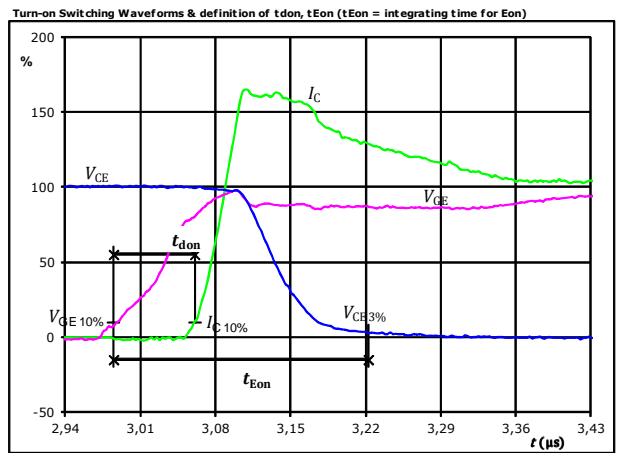
T_j	=	125 °C
R_{gon}	=	32 Ω
R_{goff}	=	32 Ω

figure 1. IGBT



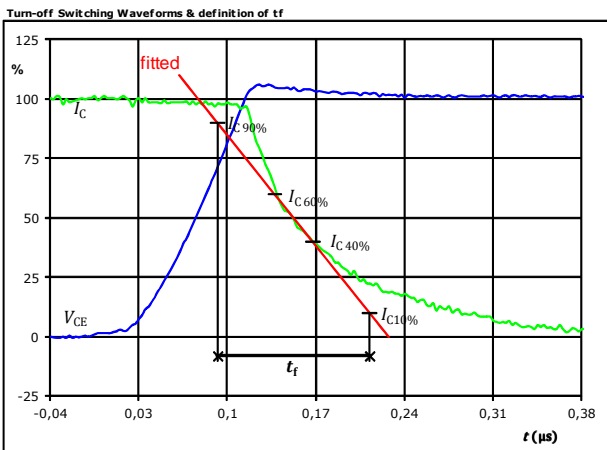
$V_{GE}(0\%)$	=	-15	V
$V_{GE}(100\%)$	=	15	V
$V_C(100\%)$	=	400	V
$I_C(100\%)$	=	10	A
t_{doff}	=	0,159	μs
t_{Eoff}	=	0,487	μs

figure 2. IGBT



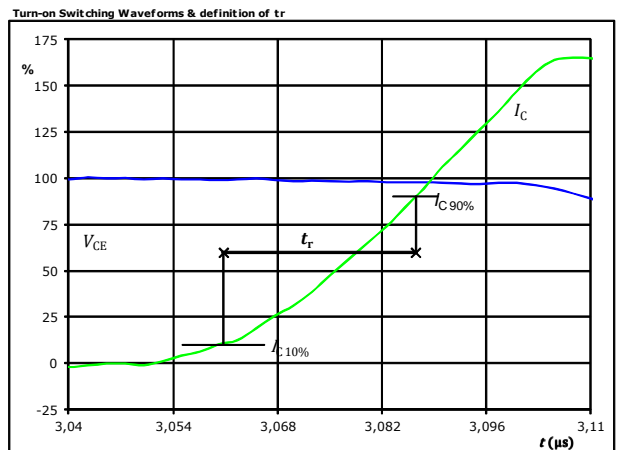
$V_{GE}(0\%)$	=	-15	V
$V_{GE}(100\%)$	=	15	V
$V_C(100\%)$	=	400	V
$I_C(100\%)$	=	10	A
t_{don}	=	0,074	μs
t_{Eon}	=	0,237	μs

figure 3. IGBT



$V_C(100\%)$	=	400	V
$I_C(100\%)$	=	10	A
t_f	=	0,123	μs

figure 4. IGBT



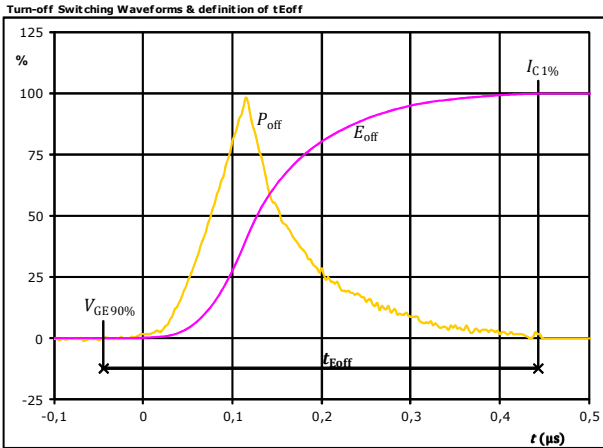
$V_C(100\%)$	=	400	V
$I_C(100\%)$	=	10	A
t_r	=	0,026	μs



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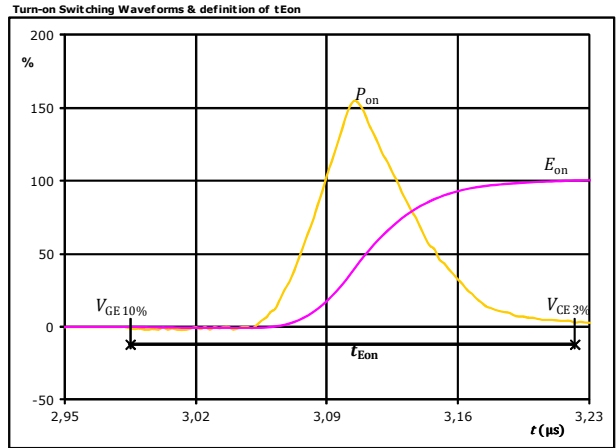
Inverter Switching Characteristics

figure 5. IGBT



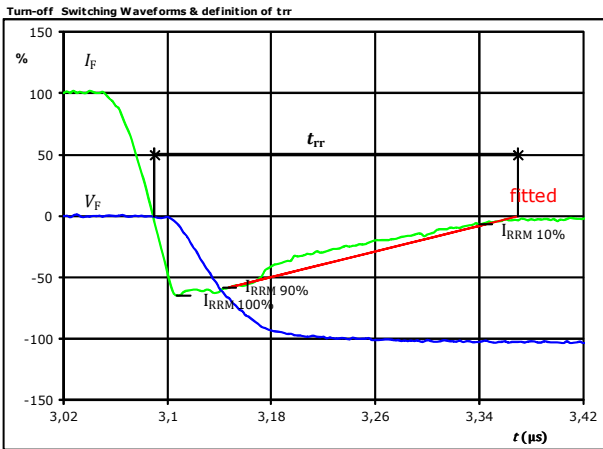
$P_{off}(100\%) = 4,00$ kW
 $E_{off}(100\%) = 0,45$ mJ
 $t_{Eoff} = 0,49$ μ s

figure 6. IGBT



$P_{on}(100\%) = 4,00$ kW
 $E_{on}(100\%) = 0,38$ mJ
 $t_{Eon} = 0,24$ μ s

figure 7. FWD



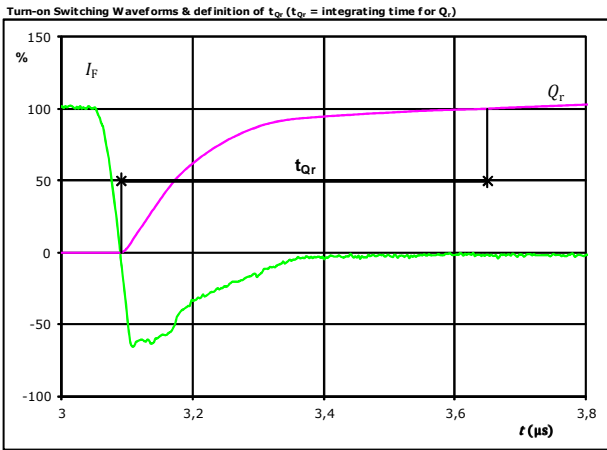
$V_F(100\%) = 400$ V
 $I_F(100\%) = 10$ A
 $I_{RRM}(100\%) = -7$ A
 $t_{rr} = 0,270$ μ s



Vincotech

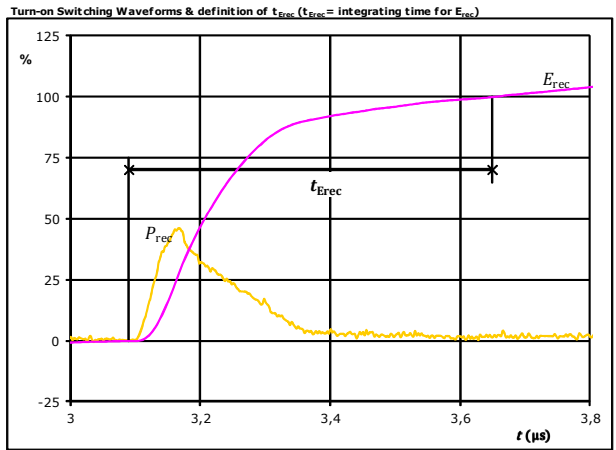
Inverter Switching Characteristics

figure 8. FWD



I_F (100%) =	10	A
Q_r (100%) =	0,90	μC
t_{Qr} =	0,56	μs


figure 9. FWD



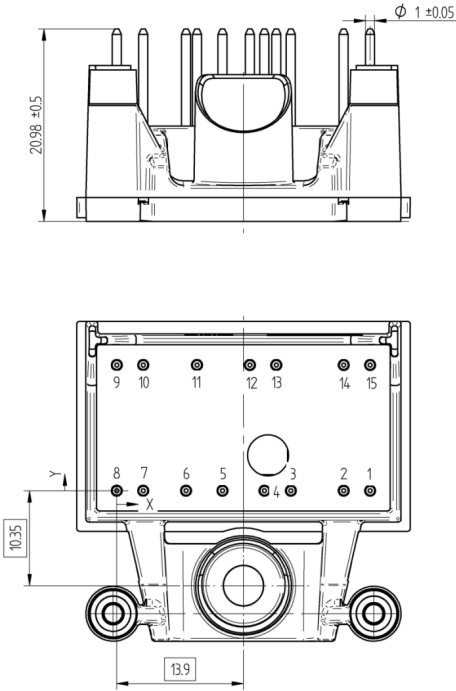
P_{rec} (100%) =	4,00	kW
E_{rec} (100%) =	0,26	mJ
t_{Erec} =	0,56	μs



Vincotech

Ordering Code & Marking																				
Version			Ordering Code																	
without thermal paste 17mm housing			10-0B066PA010SB-M993F09																	
<table border="1"> <thead> <tr> <th rowspan="2">Text</th> <th colspan="2">Name</th> <th>Type&Ver</th> <th>Date code</th> <th>Vinco & Lot</th> <th>Serial&UL</th> </tr> </thead> <tbody> <tr> <td rowspan="2">Datamatrix</td> <td>Type&Ver</td> <td>Lot number</td> <td>Serial</td> <td>Date code</td> <td></td> <td></td> </tr> </tbody> </table>							Text	Name		Type&Ver	Date code	Vinco & Lot	Serial&UL	Datamatrix	Type&Ver	Lot number	Serial	Date code		
Text	Name		Type&Ver	Date code	Vinco & Lot	Serial&UL														
	Datamatrix	Type&Ver	Lot number	Serial	Date code															
NN-NNNNNNNNNN NNNN-TTTTTTVV Vinco LLLLL WWYY SSSS UL			TTTTTTTVV	WWYY	Vinco LLLLL	SSSS UL														
			TTTTTTTVV	LLLLL	SSSS	WWYY														

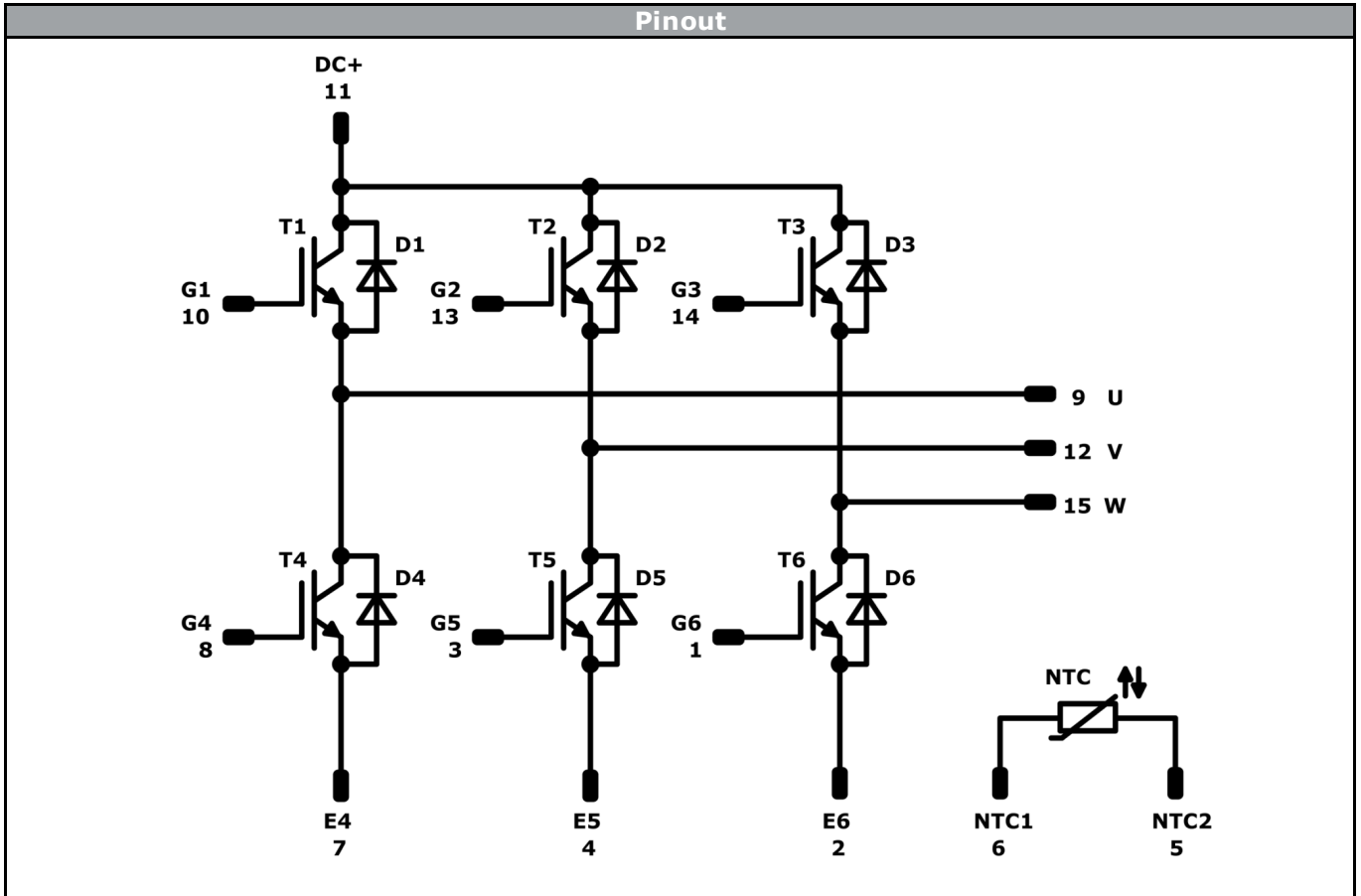
Pin table [mm]			
Pin	X	Y	Function
1	27,8	0	G6
2	24,9	0	E6
3	19,1	0	G5
4	16,2	0	E5
5	11,6	0	NTC2
6	7,6	0	NTC1
7	2,9	0	E4
8	0	0	G4
9	0	13,7	U
10	2,9	13,7	G1
11	8,8	13,7	DC+
12	14,6	13,7	V
13	17,5	13,7	G2
14	24,9	13,7	G3
15	27,8	13,7	W



Tolerance of pinpositions ±0,5mm at the end of pins
 Dimension of coordinate axis is only offset without tolerance
 PCB cutouts and holes see in handling instruction document



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Identification					
ID	Component	Voltage	Current	Function	Comment
T1-T6	IGBT	600 V	10 A	Inverter Switch	
D1-D6	FWD	600 V	10 A	Inverter Diode	
NTC	NTC			Thermistor	



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Packaging instruction			
Standard packaging quantity (SPQ)200	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow0</i> B packages see vincotech.com website.

Package data
Package data for <i>flow0</i> B packages see vincotech.com website.

Document No.:	Date:	Modification:	Pages
10-0B066PA010SB-M993F09-D2-14	08 Feb. 2016		

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